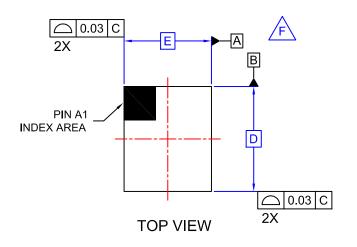
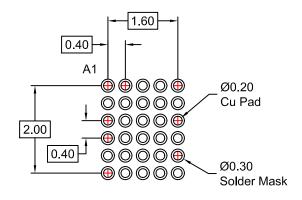


## WLCSP30 2.38x1.98x0.586

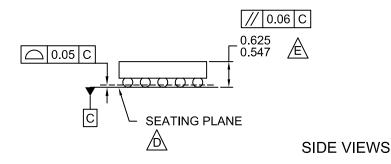
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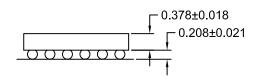
**DATE 30 NOV 2016** 

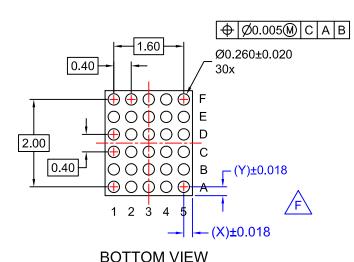




LAND PATTERN RECOMMENDATION (NSMD PAD TYPE)







## NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE

PER ASMEY14.5M, 1994.

D. DATUM C IS DEFINED BY THE SPHERICAL

CROWNS OF THE BALLS.

E PACKAGE NOMINAL HEIGHT IS 586 MICRONS

±39 MICRONS (547-625 MICRONS).

FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP30 2.38x1.98x0.586		PAGE 1 OF 1

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